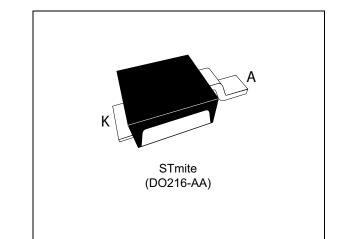
# STPS120M

# life.augmented

### Power Schottky rectifier

#### **Datasheet - production data**



### **Features**

- Very small conduction losses •
- Negligible switching losses
- Extremely fast switching •
- Low forward voltage drop for higher efficiency and extented battery life
- Low thermal resistance •
- Avalanche capability specified

Table 1. Device summary
battery powered equipment (cellular, notebook, PDA's, printers) as well chargers and PCMCIA cards.
to the small size of the package this device fits

Description

converters.

Single Schottky rectifier suited for switch mode power supplies and high frequency DC to DC

Packaged in STmite, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications. Due

	•
Symbol	Value
I <sub>F(AV)</sub>	1 A
V <sub>RRM</sub>	20 V
T <sub>j</sub> (max)	150 °C
V <sub>F</sub> (typ)	0.36 V

July 2015

This is information on a product in full production.

# 1 Characteristics

### Table 2. Absolute ratings (limiting values at $T_{amb}$ = 25 °C, unless otherwise specified)

Symbol	Parameter			Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage		20	V
I <sub>F(RMS)</sub>	Forward rms current		2	А
I <sub>F(AV)</sub>	Average forward current, $\delta = 0.5$ , square wave	1	А	
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 8.3$ ms sinusoidal		50	А
P <sub>ARM</sub> <sup>(1)</sup>	Repetitive peak avalanche power $T_j = 125 \text{ °C}, t_p = 10  \mu\text{s}$			W
T <sub>stg</sub>	Storage temperature range			°C
Т <sub>ј</sub>	Maximum operating junction temperature <sup>(2)</sup>		150	°C

 For pulse time duration deratings, please refer to *Figure 3*. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the STMicroelectronics Application notes AN1768, "Admissible avalanche power of Schottky diodes" and AN2025, "Converter improvement using Schottky rectifier avalanche specification".

2.  $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>th(j-c)</sub>	Junction to case	20	°C/W
$R_{th(j-a)}^{(1)}$	Junction to ambient		°C/W

1. Mounted with minimum recommended pad size, PC board FR4.

#### Table 4. Static electrical characteristics

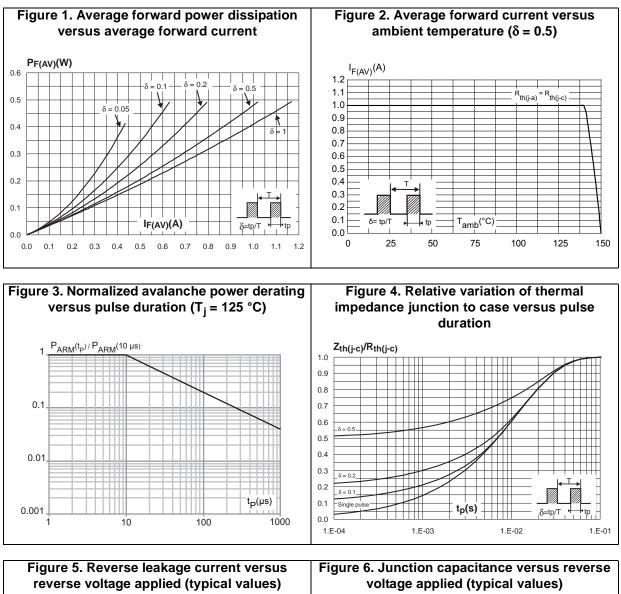
Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
		T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>	-	1.3	3.9	
		T <sub>j</sub> = 100 °C	VR = VRRM	-	275	850	
I <sub>R</sub> <sup>(1)</sup>	Bovoroo lookogo ourront	T <sub>j</sub> = 25 °C	V - 10 V	-	0.6	2.0	
'R` ′	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 100 °C	V <sub>R</sub> = 10 V	-	145	450	μA
		T <sub>j</sub> = 25 °C	V <sub>R</sub> = 5 V	-	0.4	1.0	
		T <sub>j</sub> = 100 °C	$v_R = 5 v$	-	105	300	
		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 1 A	-	0.44	0.49	
V <sub>F</sub> <sup>(1)</sup> Forward voltage drop	T <sub>j</sub> = 100 °C	IF = I A	-	0.36	0.41	V	
	Forward vollage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 2 A	-	0.48	0.54	v
		T <sub>j</sub> = 100 °C	$I_F = 2 R$	-	0.42	0.48	

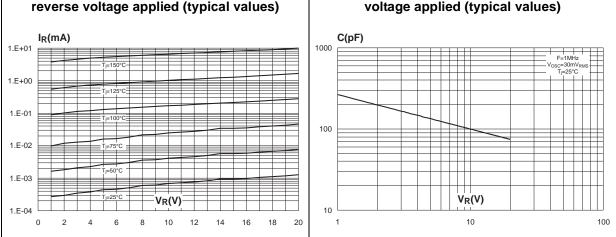
1. Pulse test:  $t_p$  = 380 µs,  $\delta$  < 2%

To evaluate the conduction losses use the following equation:

$$P = 0.34 \times I_{F(AV)} + 0.07 \times I_{F}^{2}_{(RMS)}$$

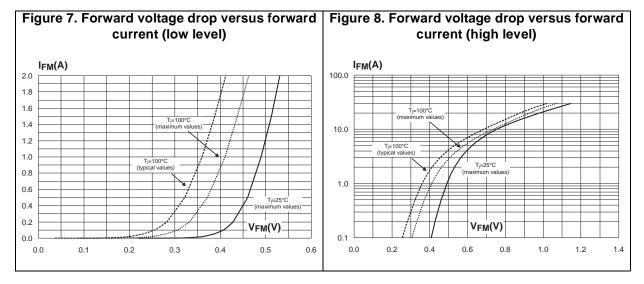




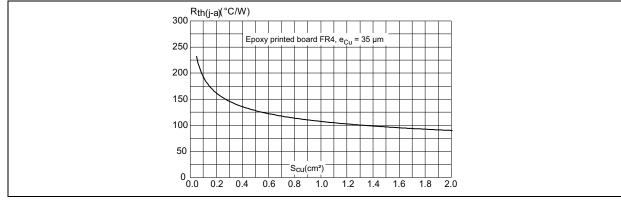


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### 2 Package information

• Epoxy meets UL94, V0

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com.* ECOPACK<sup>®</sup> is an ST trademark.

### 2.1 STmite package information

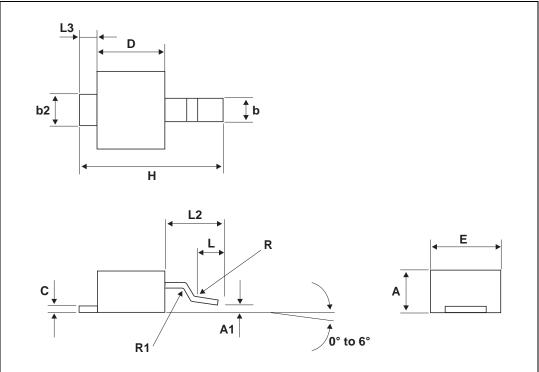


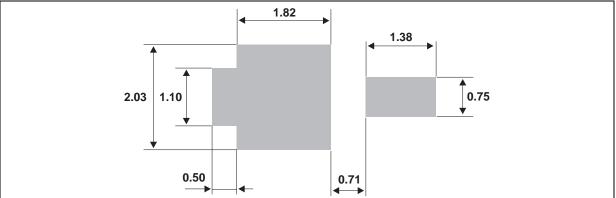
Figure 10. STmite package outline



			Dime	ensions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	0.85	1.00	1.15	0.033	0.039	0.045
A1	-0.05		0.05	-0.002		0.002
b	0.40		0.65	0.016		0.025
b2	0.70		1.00	0.027		0.039
с	0.10		0.25	0.004		0.010
D	1.75	1.90	2.05	0.069	0.007	0.081
E	1.75	1.90	2.05	0.069	0.007	0.081
Н	3.60	3.75	3.90	0.142	0.148	0.154
L	0.50	0.63	0.80	0.020	0.025	0.031
L2	1.20	1.35	1.50	0.047	0.053	0.059
L3		0.50			0.019	
R	0.07			0.003		
R1	0.07			0.03		

Table 5	STmito	nackaga	machanical data
Table 5.	Simile	package	mechanical data

### Figure 11. Footprint





# 3 Ordering information

Table 6. Ordering information	
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Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS120M	120	STmite	15.5 mg	12000	Tape and reel

# 4 Revision history

Date	Revision	Changes
Jul-2003	2A	Last update.
13-Sep-2004	3	STmite package dimensions reference A1 change: from blank (min) to -0.05mm and from 0.10 (max) to 0.05mm.
16-Feb-2011	4	Migrated from EDOCS.
20-Jul-2015	5	Updated Table 4 and reformatted to current standard.



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